

Z4RGP30MPH
FEATURES

- * Halogen-free type
- * Glass passivated chip junctions
- * Compliance to RoHS product
- * Leadless chip form, no lead damage
- * Low power loss, High efficiency
- * High current capability
- * Plastic package has Underwriters Laboratory Flammability Classification 94V-0

APPLICATION

- * AC/DC Power Supply
- * Communication Equipment

MECHANICAL DATA

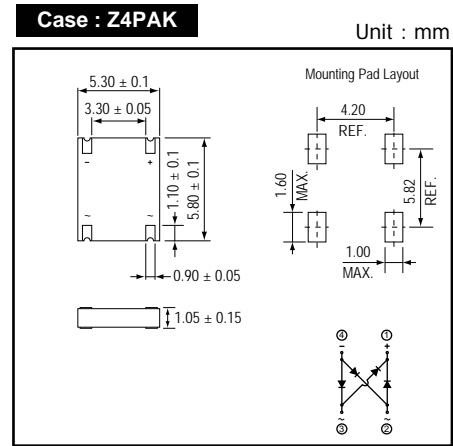
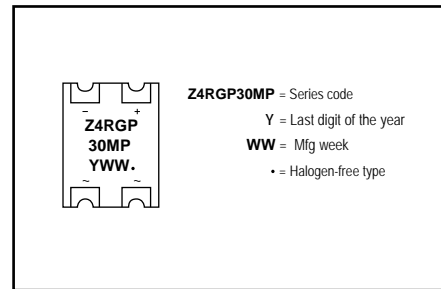
Case : Packed with FRP substrate and epoxy underfilled

Terminals : Pure Tin plated (Lead-Free),
solderable per MIL-STD-750, Method 2026.

Polarity : Laser marking symbols

PACKING

- * 5,000 pieces per 13" (330mm ± 2mm) reel
- * 2 reels per box
- * 5 boxes per carton

OUTLINE DIMENSIONS

MARKING

Absolute Maximum Ratings (Ta = 25 °C)

ITEM	Symbol	Conditions	Rating	Unit
Repetitive peak reverse voltage	VRRM		1000	V
Average forward current	IF(AV)		3	A
Peak forward surge current	IFSM	8.3ms single half sine-wave	70	A
Reverse recovery time	Trr	IF = 0.5A, IR = 1.0A, Irr = 0.25A	500	nS
Operating junction and storage temperature Range	Tj, TSTG		-55 to +150	°C

Electrical characteristics (Ta = 25 °C)

ITEM	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward voltage	VF	@ IF = 3A Ta = 25 °C	-	1.10	1.30	V
Repetitive peak reverse current	IRRM	VR = Max. VRRM Ta = 25 °C	-	0.20	5	µA
Current squared time	I ² t	t < 8.3ms, Ta = 25 °C	-	20.3	-	A ² s
Thermal resistance	Rth(JA)	Junction to ambient (NOTE)	-	95	-	°C/W
	Rth(JC)	Junction to case (NOTE)	-	15	-	

NOTES : (1) Thermal resistance, junction to ambient, measured on PC board with 50mm² (0.03mm thick) land areas.

(2) Preliminary specification

FIG.1 - FORWARD CURRENT DERATING CURVE

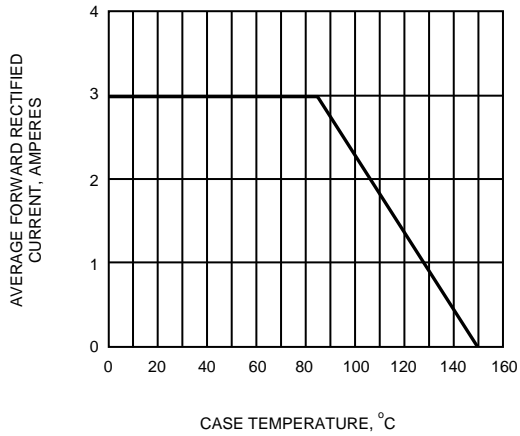


FIG.2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

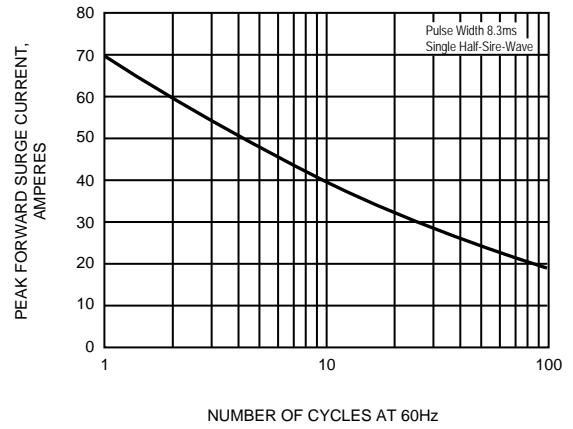


FIG.3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

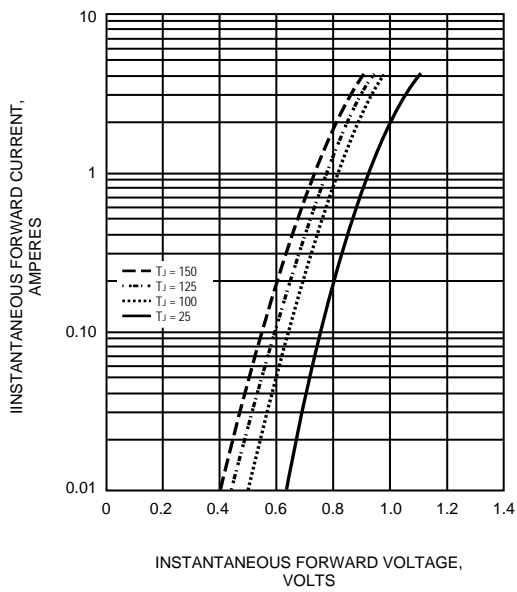


FIG.4 - TYPICAL REVERSE CHARACTERISTICS

